TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LVX4245FS

Dual Supply Octal Bus Transceiver

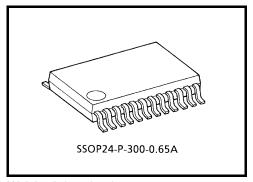
The TC74LVX4245FS is a dual supply, advanced high-speed CMOS octal bus transceiver fabricated with silicon gate CMOS technology.

Designed for use as an interface between a 5V bus and a 3.3V bus in mixed 5V/3.3V supply systems' it achieves high-speed operation while maintaining the CMOS low power dissipation.

It is intended for 2 way asynchronous communication between data busses. The direction of data transmission is determined by the level of the DIR input.

The enable input (\overline{G}) can be used to disable the device so that the buses are effectively isolated. The A-port interfaces with the 5V bus, the B-port with the 3.3V bus.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.



Weight: 0.14 g (typ.)

Features

- Bi-directional interface between 5 V and 3 V buses
- High-speed: t_{pd} = 6.0 ns (typ.)

 $(V_{CCA} = 5.0 \text{ V}, V_{CCB} = 3.3 \text{ V})$

- Low power dissipation: I_{CC} = 8 μA (max) (Ta = 25°C)
- Symmetrical output impedance: I_{OUTA} = ±24 mA (min)

 $I_{OUTB} = \pm 12 \text{ mA (min)}$

 $(V_{CCA} = 4.5 \text{ V}, V_{CCB} = 3.0 \text{ V})$

- Low noise: V_{OLP} = 1.5 V (max)
- Package: SSOP (shrink small outline package)

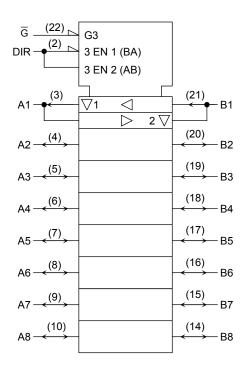
Note 1: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

All floating (high impedance) bus pin must have their input levels fixed by means of pull up or pull down resistors.

Pin Assignment (top view)

V_{CCA} 24 V_{CCB} DIR 2 23 V_{CCB} $\overline{\mathsf{G}}$ Α1 Α2 В1 А3 5 20 В2 A4 6 19 В3 Α5 18 B4 Α6 8 В5 Α7 9 16 В6 A8 10 В7 15 GND 11 B8 GND 12 **GND**

IEC Logic Symbol



Truth Table

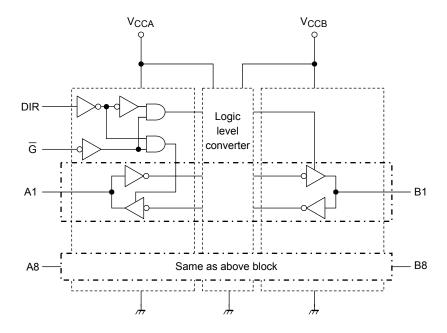
Inn	uite		Function				
Inputs		Outputs	Function				
G	DIR	Outputs	A-Bus	B-Bus			
L	L	A = B	Output	Input			
L	Н	B = A	Input	Output			
Н	Х	Z	High impedance				

X: Don't care

Z: High impedance



Block Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CCA}	-0.5 to 7.0	V
(Note	2) V _{CCB}	-0.5 to $V_{CCA} + 0.5$	v
DC input voltage	V _{IN}	-0.5 to $V_{CCA} + 0.5$	V
DC bus I/O voltage	V _{I/OA}	-0.5 to $V_{CCA} + 0.5$	V
Do bus 1/O voltage	V _{I/OB}	-0.5 to $V_{CCB} + 0.5$	V
Input diode current	lıK	-20	mA
Output diode current	I _{I/OK}	±50	mA
DC output current	I _{OUTA}	±50	mA
Do output current	I _{OUTB}	±50	ША
DC V _{CC} /ground current	I _{CCA}	±200	mA
DO VOO/ground current	I _{CCB}	±100	IIIA
Power dissipation	PD	180	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Note 2: $V_{CCA} > V_{CCB}$ Don't use under the condition that V_{CCB} is 0 V.



Operating Range (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CCA}	4.5 to 5.5	V
Supply voltage	V _{CCB}	2.7 to 3.6	V
Input voltage	V _{IN}	0 to V _{CCA}	V
Bus I/O voltage	V _{I/OA}	0 to V _{CCA}	V
bus I/O voltage	V _{I/OB}	0 to V _{CCB}	V
Operating temperature	T _{opr}	-40 to 85	°C
		0 to 8	
Input rise and fall time	dt/dv	$(V_{CCA} = 4.5 \text{ to } 5.5 \text{ V})$	ns/V
input rise and rail time	uluv	0 to 8	115/ V
		(V _{CCB} = 2.7 to 3.6 V)	

Note: The operating range is required to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either VCC or GND. Please connect both bus inputs and the bus outputs with VCC or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

Electrical Characteristics

DC Characteristics (V_{CCA}) (V_{CCB} = 2.7 to 3.6 V)

Characteristics		Symbol	Test Condition		Test Condition		Ta = 25°C			Ta = -40 to 85°C	
					V _{CCA} (V)	Min	Тур.	Max	Min	Max	
Input voltage	H-level	V _{IHA}	DIR, \overline{G} , An		4.5 to 5.5	2.0	_	_	2.0	_	V
input voltage	L-level	V _{ILA}	DIR, $\overline{\overline{G}}$, An		4.5 to 5.5		_	0.8		0.8	V
	H-level	Vous	V _{INA} = V _{IHA} or V _{ILA}	I _{OH} = -100 μA	4.5	4.4	4.5		4.4		
Output voltage	Ti-level	V _{OHA}	V _{INB} = V _{IHB} or V _{ILB}	I _{OH} = -24 mA	4.5	3.86	_	ı	3.76		V
L-leve	L-level V _{OLA}	V _{INA} = V _{IHA} or V _{ILA}	I _{OL} = 100 μA	4.5		0.0	0.1		0.1	V	
	L-level	VOLA	V _{INB} = V _{IHB} or V _{ILB}	I _{OL} = 24 mA	4.5	_	_	0.36	_	0.44	
3-state output Off-state curren	3-state output I_{OZA} $V_{INA} = V_{IHA}$ or V_{ILA} $V_{INB} = V_{IHB}$ or V_{ILB} $V_{I/OA} = V_{CCA}$ or GND		V_{ILB}	5.5		_	±0.5		±5.0	μА	
Input leakage current I _{INA}		V _{IN} (DIR, \overline{G}) = V _{CCA} or GND		5.5	_	_	±0.1	_	±1.0	μА	
Quiescent supply current		ICCA	$V_{INA} = V_{CCA}$ or GND $V_{INB} = V_{CCB}$ or GND		5.5		_	8.0		80.0	μА
		I _{CCTA}	V _{INA} = 3.4 V (per input) V _{CCA} or GND (other input)		5.5	_	_	2.3	_	2.5	mA

DC Characteristics (V_{CCB}) ($V_{CCA} = 4.5$ to 5.5 V)

Characteristics Syn		Symbol	nbol Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
					V _{CCB} (V)	Min	Тур.	Max	Min	Max	
H-level		V _{IHB}	Bn		2.7	2.0	_	_	2.0	_	
Input voltage	i i-levei	VIHB	ы		3.6	2.2	_		2.2		V
mpat voltage	L-level	V _{ILB}	Bn		2.7	-	_	0.8	-	0.8	·
	L-ICVCI	VILB	ы		3.6	_	_	0.8	_	0.8	
				I _{OH} = -100 μA	3.0	2.9	3.0		2.9		
	H-level	H-level V _{OHB}	VINA = VIHA or VILA	I _{OH} = -8 mA	2.7	2.26	_	l	2.20	l	
Outrout walks as				I _{OH} = -12 mA	3.0	2.48	_		2.40		
Output voltage		L-level V _{OLB}	VINA = VIHA or VILA	I _{OL} = 100 μA	3.0	_	0.0	0.1	_	0.1	V
	L-level			I _{OL} = 8 mA	2.7	_	_	0.31	_	0.40	
				I _{OL} = 12 mA	3.0	_	_	0.31	_	0.40	
3-state output		loza	V _{INA} = V _{IHA} or '	V _{ILA}	3.6			±0.5	_	±5.0	μА
Off-state curren	t	IOZB	$V_{I/OB} = V_{CCB}$ or GND		5.0			±0.5		±3.0	μΛ
		I _{CCB}	V _{INA} = V _{CCA} or GND		3.6	_	_	5.0	_	50.0	μА
Quiescent supp	ly current			V _{INB} = V _{CCB} or GND							
		Ісств	V _{INA} = 3.0 V (per input) V _{CCB} or GND (other input)		3.6			0.35		0.50	mA

AC Characteristics (input: $t_r=t_f=3$ ns, $C_L=50$ pF, $R_L=500~\Omega,\,V_{CCA}=5.0\pm0.5~V)$

Characteristics	Symbol	Test Condition		-	Γa = 25°0		Ta = - 85	Unit	
			V _{CC} (V)	Min	Тур.	Max	Min	Max	
Propagation delay time	t _{pLH}		2.7	_	7.1	9.5	1.0	10.5	ns
(An⇒Bn)	t_{pHL}	Innut: An	3.3 ± 0.3	_	6.5	8.6	1.0	9.5	115
3-state output enable time	t _{pZL}	Input: An Outpu: Bn	2.7	_	9.5	12.5	1.0	13.8	no
(G ⇒Bn)	t_{pZH}	(DIR = "H")	3.3 ± 0.3	_	8.6	11.4	1.0	12.5	ns
3-state output disable time	t _{pLZ}	(DIK = H)	2.7	_	5.3	9.1	1.0	10.0	20
(G ⇒Bn)	t_{pHZ}		3.3 ± 0.3	_	5.3	9.1	1.0	10.0	ns
Propagation delay time	t _{pLH}		2.7	_	7.0	9.5	1.0	10.5	20
(Bn⇒An)	t_{pHL}	5	3.3 ± 0.3	_	6.4	8.6	1.0	9.5	ns
3-state output enable time	t _{pZL}	Input: Bn	2.7	_	8.5	11.6	1.0	12.7	
(G ⇒An)	t_{pZH}	Output: An (DIR = "L")	3.3 ± 0.3	_	7.7	10.5	1.0	11.5	ns
3-state output disable time	t _{pLZ}	(DIK = L)	2.7		5.1	6.8	1.0	7.5	
(G ⇒An)	t_{pHZ}		3.3 ± 0.3		5.1	6.8	1.0	7.5	ns
Output to output alray	t _{osLH}	(1)-1-4	2.7	_	_	1.5	_	1.5	20
Output to output skew	t _{osHL}	(Note 1)	3.3 ± 0.3		_	1.5	_	1.5	ns
Input capacitance	C _{INA}	DIR, G	3.3 ± 0.3		5	10	_	10	pF
Bus input capacitance	C _{I/O}	An, Bn	3.3 ± 0.3		13	_	_	_	pF
	C ·	A⇒B (DIR = "H")	3.3 ± 0.3	_	17	_	_	_	pF
Power dissipation capacitance	C _{PDA}	B⇒A (DIR = "L")	3.3 ± 0.3	_	25	_	_	_	
(Note 2)		A⇒B (DIR = "H")	3.3 ± 0.3	_	4	_	_	_	
	C _{PDB}	B⇒A (DIR = "L")	3.3 ± 0.3	_	4	_	_	_	

Note 1: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|)$

Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$

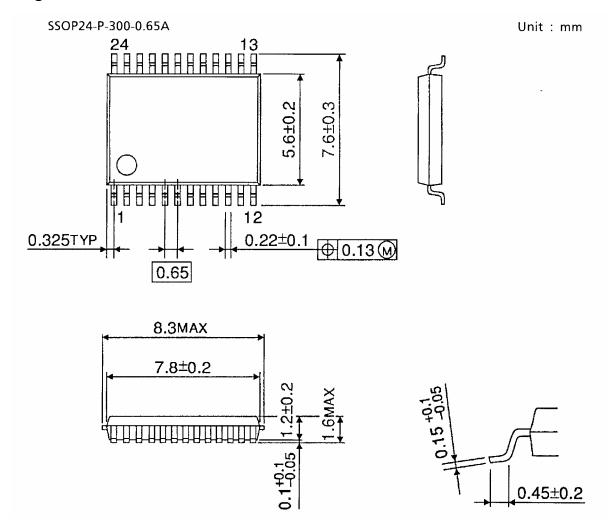
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Noise Characteristics (Ta = 25°C, input: $t_r = t_f = 3$ ns, $C_L = 50$ pF, $R_L = 500~\Omega$)

Characteristics		Symbol Test Condition				Тур.	Limit	Unit	
Characteristics		Symbol	rest Condition	V _{CCA} (V)	V _{CCB} (V)	τyp.	Liiiii	Offic	
Quiet output maximum dynamic	V _{OL} (A)	V _{OLPA}	Input: Bn	5.0	3.3	1.0	1.5	V	
Quiet output mimimum dynamic	V _{OL} (A)	V _{OLVA}	Output: An (DIR = "L")	5.0	3.3	-0.6	-1.2	V	
Quiet output maximum dynamic	V _{OL} (B)	V _{OLPB}	Input: An	5.0	3.3	0.8	1.2	V	
Quiet output mimimum dynamic	V _{OL} (B)	V _{OLVB}	Output: Bn (DIR = "H")	5.0	3.3	-0.5	-0.8	٧	
Minimum high level dynamic input voltage	V _{IH} (A)	V _{IHDA}	Input: An	5.0	3.3		2.0	V	
Maximum low level dynamic input voltage	V _{IL} (A)	V _{ILDA}	Input: An	5.0	3.3	l	0.8	V	
Minimum high level dynamic input voltage	V _{IH} (B)	V _{IHDB}	Input: Bn	5.0	3.3		2.0	V	
Maximum low level dynamic input voltage	V _{IL} (B)	V _{ILDB}	Input: Bn	5.0	3.3		0.8	V	

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Package Dimensions



Weight: 0.14 g (typ.)

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